



flowBOOST 0 dual SiC

650 V / 42 mΩ

Features

- High efficiency dual booster
- Low Inductance Layout
- Ultra fast switching frequency
- Integrated temperature sensor

Target applications

- Power Supply
- Solar Inverters

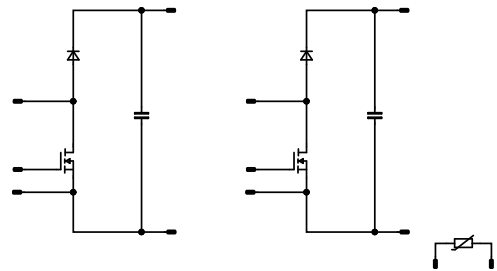
Types

- 10-FZ07B2A042UF01-PB53L93

flow 0 12 mm housing



Schematic





Vincotech

10-FZ07B2A042UF01-PB53L93
datasheet

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Boost Switch				
Drain-source voltage	V_{DSS}		650	V
Drain current (DC current)	I_D	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	24	A
Peak drain current	I_{DM}	t_p limited by T_{jmax}	125	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	38	W
Gate-source voltage	V_{GSS}		± 25	V
Maximum Junction Temperature	T_{jmax}		175	°C
Boost Diode				
Peak repetitive reverse voltage	V_{RRM}		650	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	28	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	92	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10\text{ ms}$	180	A
Surge current capability	I^2t		162	A ² s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	60	W
Maximum junction temperature	T_{jmax}		175	°C
Capacitor (DC)				
Maximum DC voltage	V_{MAX}		630	V
Operation Temperature	T_{op}		-55 ... 150	°C



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10-FZ07B2A042UF01-PB53L93
datasheet

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
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Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	°C
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	°C

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage* $t_p = 2\text{ s}$	6000	V
Isolation voltage	V_{isol}	AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance			>12,7	mm
Clearance			9,1	mm
Comparative Tracking Index	CTI		≥ 200	

*100 % tested in production



Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GS} [V]	V_{GE} [V]	V_{DS} [V]	I_C [A]	T_j [°C]	Min	Typ	Max	

Boost Switch

Static

Drain-source on-state resistance	$r_{DS(on)}$		12		30	25 125 150		43 60 67	52 ⁽¹⁾	mΩ
Gate-source threshold voltage	$V_{GS(th)}$		0		0,01	25	4	5	6	V
Gate to Source Leakage Current	I_{GSS}		20	0		25		6	20	μA
Zero Gate Voltage Drain Current	I_{DSS}		0	650		25		0,7	150	μA
Internal gate resistance	r_g							4,5		Ω
Gate charge	Q_g		-5/12	400	30	25		43		nC
Short-circuit input capacitance	C_{iss}	$f = 100$ kHz	0	100	0	25		1500		pF
Short-circuit output capacitance	C_{oss}							200		
Reverse transfer capacitance	C_{rss}							2,2		
Diode forward voltage	V_{SD}		0		20	25		1,5	1,75	V

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						2,49		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 4 \Omega$ $R_{goff} = 4 \Omega$	0/12	400	40	25		18,88		ns
						125		18,56		
						150		18,24		
Rise time	t_r					25		6,08		
						125		5,44		
						150		5,44		
Turn-off delay time	$t_{d(off)}$					25		37,12		
		125		37,12						
		150		37,76						
Fall time	t_f	25		7,54						
		125		4,85						
		150		5,18						
Turn-on energy (per pulse)	E_{on}	$Q_{rFWD} = 0,063 \mu C$				25		0,148		mWs
		$Q_{rFWD} = 0,064 \mu C$				125		0,122		
		$Q_{rFWD} = 0,062 \mu C$				150		0,124		
Turn-off energy (per pulse)	E_{off}					25		0,075		mWs
						125		0,052		
						150		0,056		



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		
Boost Diode										
Static										
Forward voltage	V_F				20	25 125 150		1,47 1,67 1,75	1,8 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 650$ V				25		24	120	μA
Thermal										
Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,58		K/W
Dynamic										
Peak recovery current	I_{RRM}					25 125 150		18,9 20,79 21,11		A
Reverse recovery time	t_{rr}					25 125 150		7,58 7,73 7,74		ns
Recovered charge	Q_r	$di/dt=5311$ A/μs $di/dt=6589$ A/μs $di/dt=6502$ A/μs	0/12	400	40	25 125 150		0,063 0,064 0,062		μC
Reverse recovered energy	E_{rec}					25 125 150		$5,851 \times 10^{-3}$ 0,014 0,014		mWs
Peak rate of fall of recovery current	$(di_r/dt)_{max}$					25 125 150		6414 7432 7310		A/μs



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GS} [V]	V_{GE} [V]	V_{DS} [V]	V_{CE} [V]	T_j [°C]	Min	Typ	Max	

Capacitor (DC)

Static

Capacitance	C	DC bias voltage = 0 V				25		33		nF
Tolerance							-5		5	%

Thermistor

Static

Rated resistance	R					25		22		kΩ
Deviation of R_{100}	Δ_{RR}	$R_{100} = 1484 \Omega$				100	-5		5	%
Power dissipation	P							5		mW
Power dissipation constant	d					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 1 \%$						3962		K
B-value	$B_{(25/100)}$	Tol. $\pm 1 \%$						4000		K
Vincotech Thermistor Reference									I	

⁽¹⁾ Value at chip level

⁽²⁾ Only valid with pre-applied Vincotech thermal interface material.

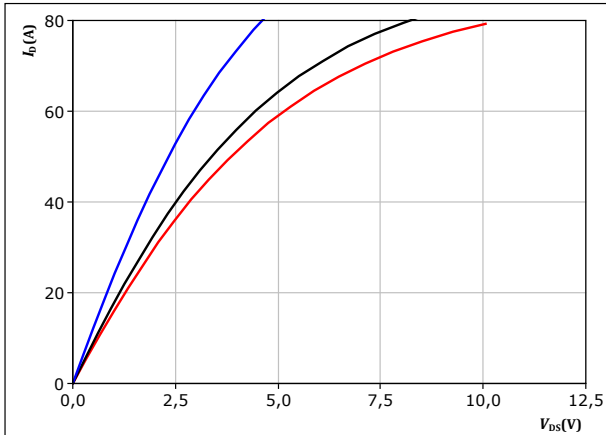


Boost Switch Characteristics

figure 1. MOSFET

Typical output characteristics

$$I_D = f(V_{DS})$$

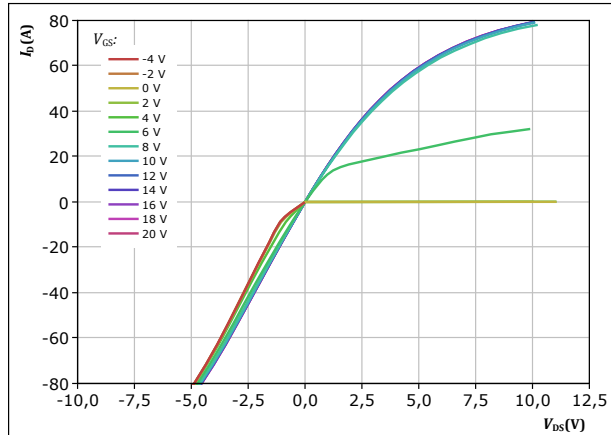


$t_p = 250 \mu s$
 $V_{GS} = 12 V$
 $T_j:$ 25 °C, 125 °C, 150 °C

figure 2. MOSFET

Typical output characteristics

$$I_D = f(V_{DS})$$

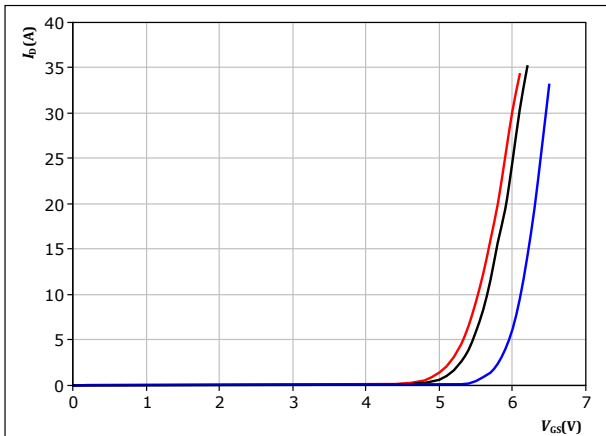


$t_p = 250 \mu s$
 $T_j = 150 \text{ } ^\circ\text{C}$
 V_{GS} from -4 V to 20 V in steps of 2 V

figure 3. MOSFET

Typical transfer characteristics

$$I_D = f(V_{GS})$$

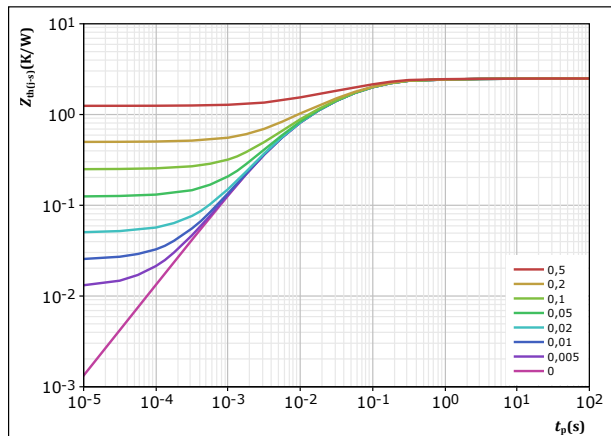


$t_p = 250 \mu s$
 $V_{DS} = 10 V$
 $T_j:$ 25 °C, 125 °C, 150 °C

figure 4. MOSFET

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 2,494 \text{ K/W}$
MOSFET thermal model values

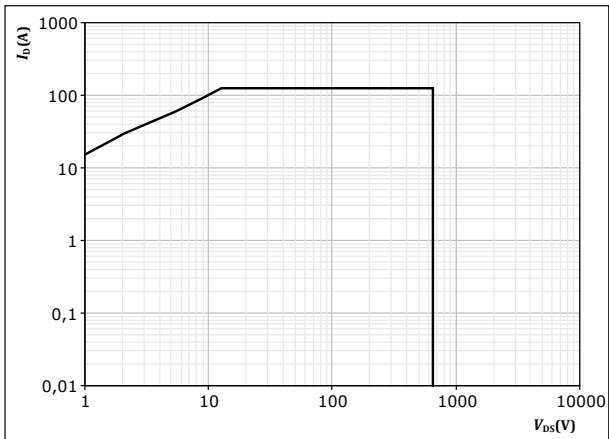
R (K/W)	τ (s)
3,22E-02	9,01E+00
9,03E-02	1,04E+00
1,04E+00	9,78E-02
8,96E-01	2,16E-02
4,53E-01	4,76E-03
-1,36E-02	9,57E-04



Boost Switch Characteristics

figure 5. MOSFET

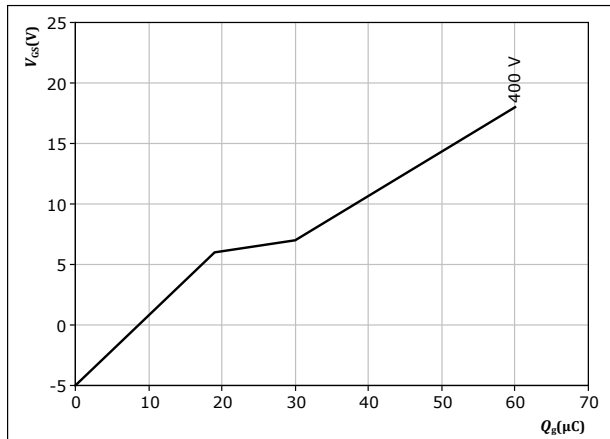
Safe operating area
 $I_D = f(V_{DS})$



$D =$ single pulse
 $T_s = 80$ °C
 $V_{GS} = 12$ V
 $T_j = T_{jmax}$

figure 6. MOSFET

Gate voltage vs gate charge
 $V_{GS} = f(Q_g)$



$I_D = 30$ A
 $T_j = 25$ °C



Boost Diode Characteristics

figure 7. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

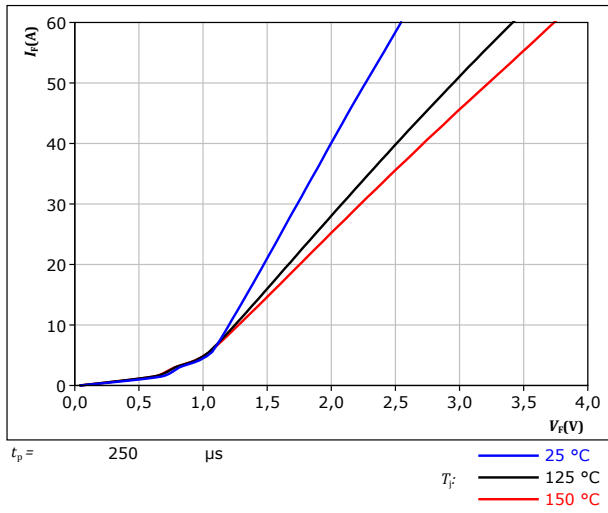
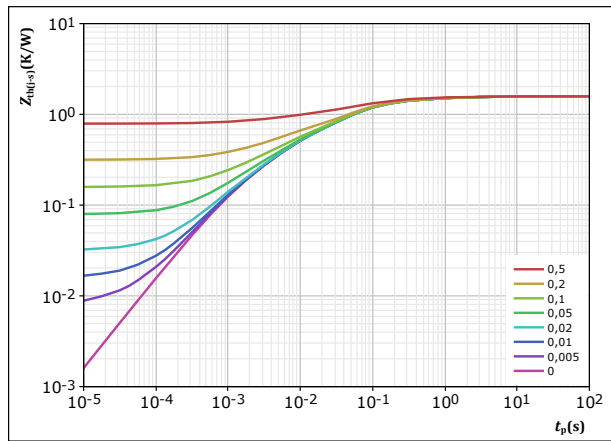


figure 8. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,58 \text{ K/W}$
 FWD thermal model values

R (K/W)	τ (s)
8,96E-02	2,60E+00
2,36E-01	2,99E-01
8,04E-01	5,52E-02
3,49E-01	6,69E-03
1,01E-01	1,09E-03

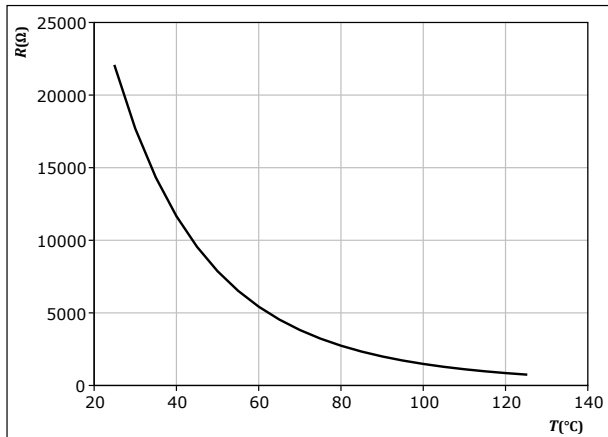


Thermistor Characteristics

figure 9. Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$

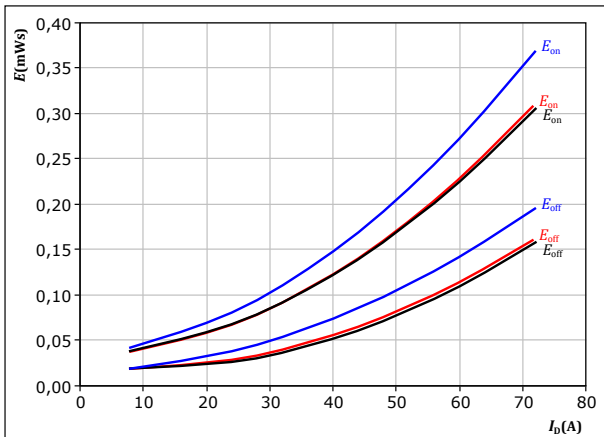




Boost Switching Characteristics

figure 10. MOSFET

Typical switching energy losses as a function of drain current
 $E = f(I_D)$



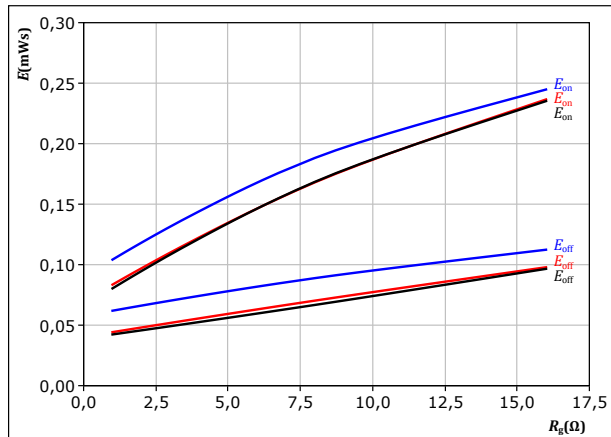
With an inductive load at

$V_{DS} = 400 \text{ V}$
 $V_{GS} = 0/12 \text{ V}$
 $R_{g\text{on}} = 4 \ \Omega$
 $R_{g\text{off}} = 4 \ \Omega$

T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 11. MOSFET

Typical switching energy losses as a function of gate resistor
 $E = f(R_g)$



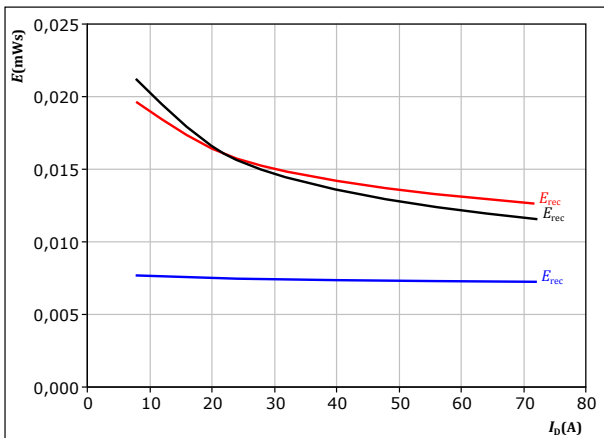
With an inductive load at

$V_{DS} = 400 \text{ V}$
 $V_{GS} = 0/12 \text{ V}$
 $I_D = 40 \text{ A}$

T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 12. FWD

Typical reverse recovered energy loss as a function of drain current
 $E_{rec} = f(I_D)$



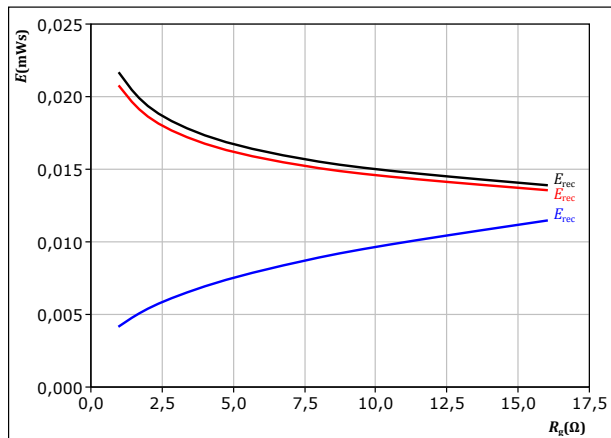
With an inductive load at

$V_{DS} = 400 \text{ V}$
 $V_{GS} = 0/12 \text{ V}$
 $R_{g\text{on}} = 4 \ \Omega$

T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 13. FWD

Typical reverse recovered energy loss as a function of gate resistor
 $E_{rec} = f(R_g)$



With an inductive load at

$V_{DS} = 400 \text{ V}$
 $V_{GS} = 0/12 \text{ V}$
 $I_D = 40 \text{ A}$

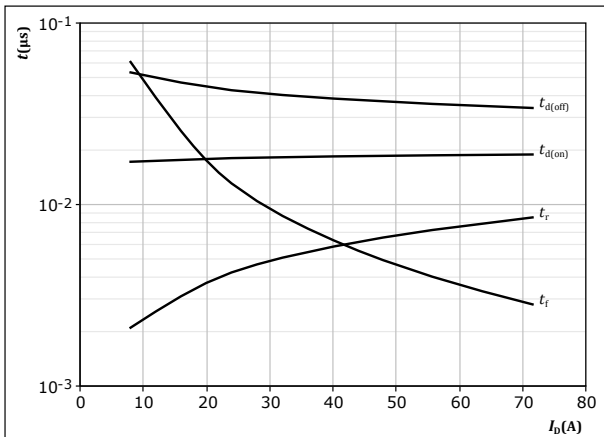
T_j : 25 °C (blue), 125 °C (black), 150 °C (red)



Boost Switching Characteristics

figure 14. MOSFET

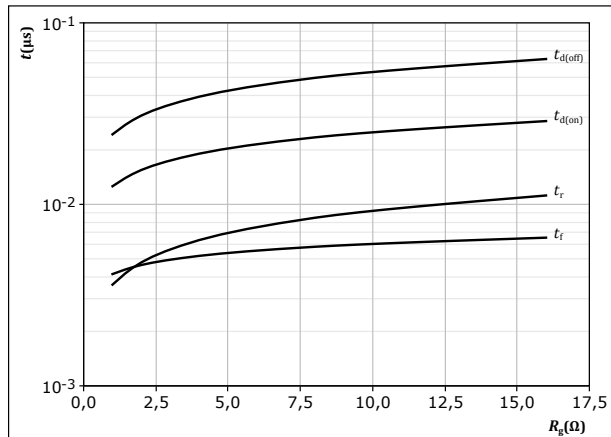
Typical switching times as a function of drain current
 $t = f(I_D)$



With an inductive load at
 $T_j = 150 \text{ }^\circ\text{C}$
 $V_{DS} = 400 \text{ V}$
 $V_{GS} = 0/12 \text{ V}$
 $R_{g(on)} = 4 \text{ } \Omega$
 $R_{g(off)} = 4 \text{ } \Omega$

figure 15. MOSFET

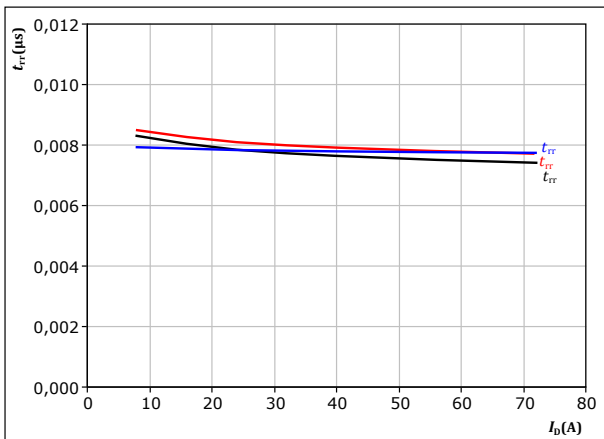
Typical switching times as a function of gate resistor
 $t = f(R_g)$



With an inductive load at
 $T_j = 150 \text{ }^\circ\text{C}$
 $V_{DS} = 400 \text{ V}$
 $V_{GS} = 0/12 \text{ V}$
 $I_D = 40 \text{ A}$

figure 16. FWD

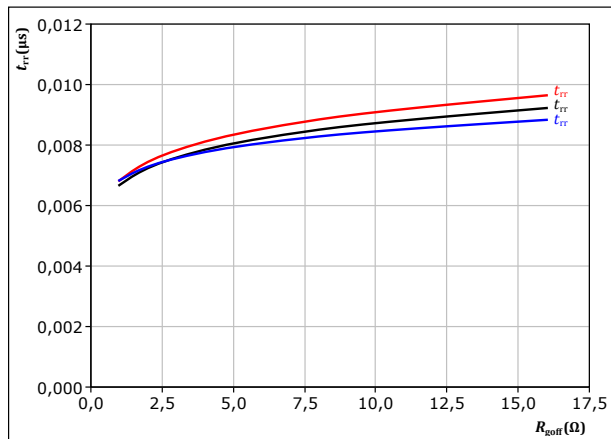
Typical reverse recovery time as a function of drain current
 $t_{rr} = f(I_D)$



At $V_{DS} = 400 \text{ V}$
 $V_{GS} = 0/12 \text{ V}$
 $R_{g(on)} = 4 \text{ } \Omega$
 $T_j: 25 \text{ }^\circ\text{C}$
 $125 \text{ }^\circ\text{C}$
 $150 \text{ }^\circ\text{C}$

figure 17. FWD

Typical reverse recovery time as a function of turn off gate resistor
 $t_{rr} = f(R_{g(off)})$



At $V_{DS} = 400 \text{ V}$
 $V_{GS} = 0/12 \text{ V}$
 $I_D = 40 \text{ A}$
 $T_j: 25 \text{ }^\circ\text{C}$
 $125 \text{ }^\circ\text{C}$
 $150 \text{ }^\circ\text{C}$

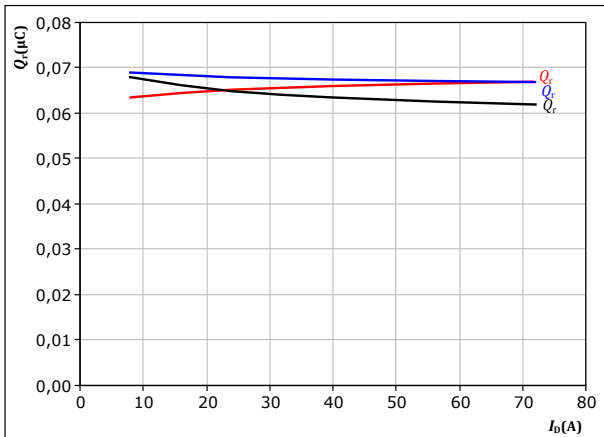


Boost Switching Characteristics

figure 18. FWD

Typical recovered charge as a function of drain current

$$Q_r = f(I_D)$$



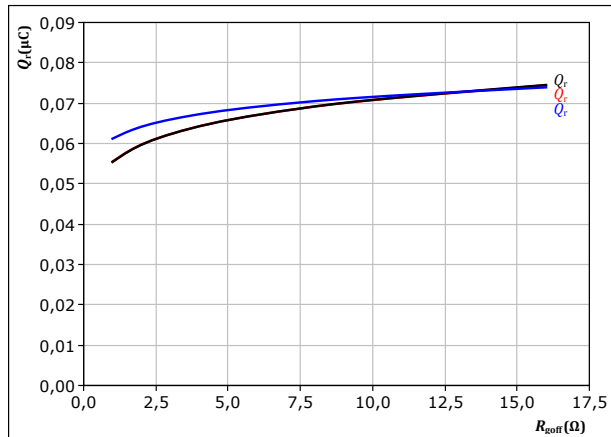
At $V_{DS} = 400$ V
 $V_{GS} = 0/12$ V
 $R_{goff} = 4$ Ω

T_j : — 25 °C
 — 125 °C
 — 150 °C

figure 19. FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



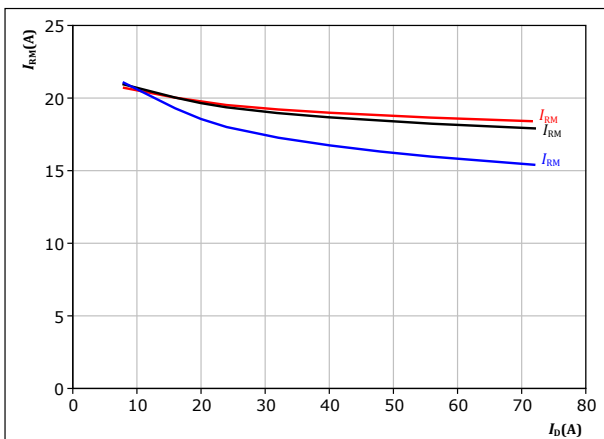
At $V_{DS} = 400$ V
 $V_{GS} = 0/12$ V
 $I_D = 40$ A

T_j : — 25 °C
 — 125 °C
 — 150 °C

figure 20. FWD

Typical peak reverse recovery current as a function of drain current

$$I_{RM} = f(I_D)$$



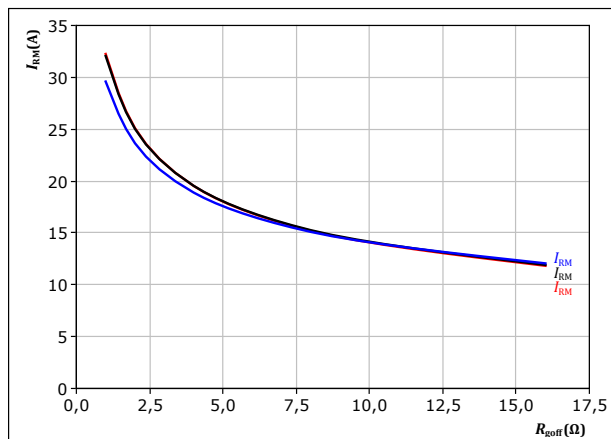
At $V_{DS} = 400$ V
 $V_{GS} = 0/12$ V
 $R_{goff} = 4$ Ω

T_j : — 25 °C
 — 125 °C
 — 150 °C

figure 21. FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



At $V_{DS} = 400$ V
 $V_{GS} = 0/12$ V
 $I_D = 40$ A

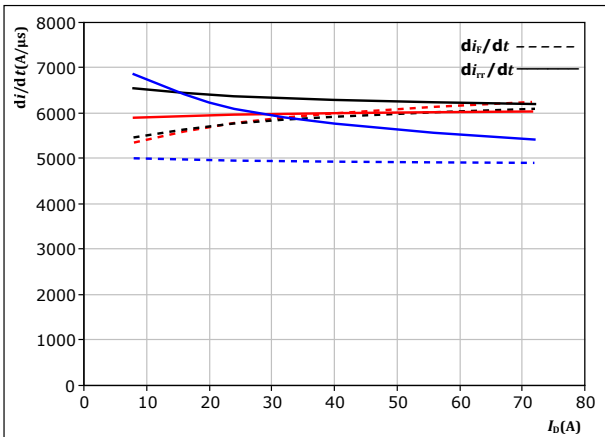
T_j : — 25 °C
 — 125 °C
 — 150 °C



Boost Switching Characteristics

figure 22. FWD

Typical rate of fall of forward and reverse recovery current as a function of drain current
 $di_f/dt, di_{rr}/dt = f(I_D)$

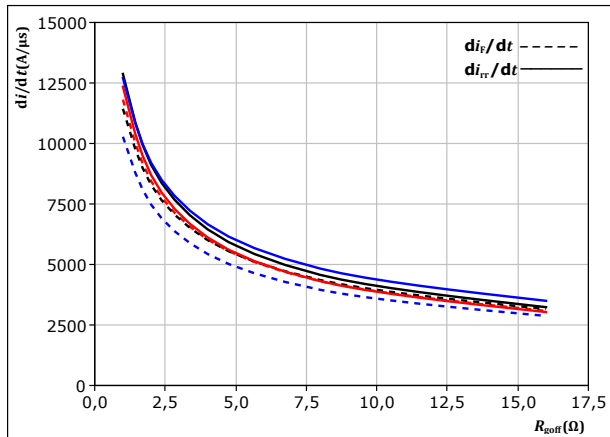


At $V_{DS} = 400$ V
 $V_{GS} = 0/12$ V
 $R_{goff} = 4$ Ω

T_j : 25 °C (blue)
 125 °C (black)
 150 °C (red)

figure 23. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{goff})$



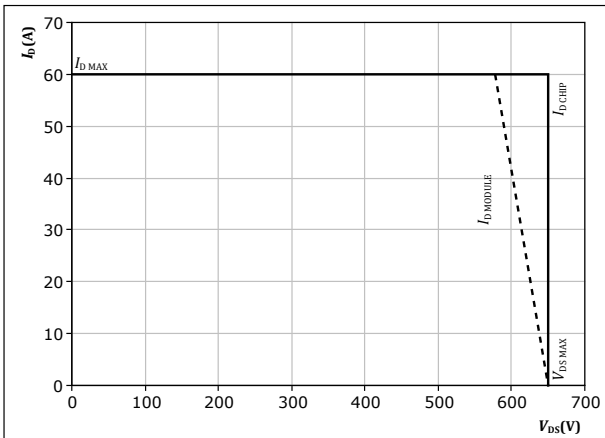
At $V_{DS} = 400$ V
 $V_{GS} = 0/12$ V
 $I_D = 40$ A

T_j : 25 °C (blue)
 125 °C (black)
 150 °C (red)

figure 24. MOSFET

Reverse bias safe operating area

$I_D = f(V_{DS})$



At $T_j = 150$ °C
 $R_{goff} = 4$ Ω
 $R_{goff} = 4$ Ω



Boost Switching Definitions

figure 25. MOSFET

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

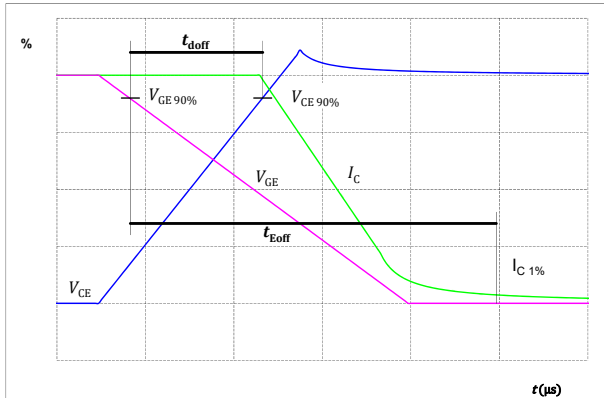


figure 26. MOSFET

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

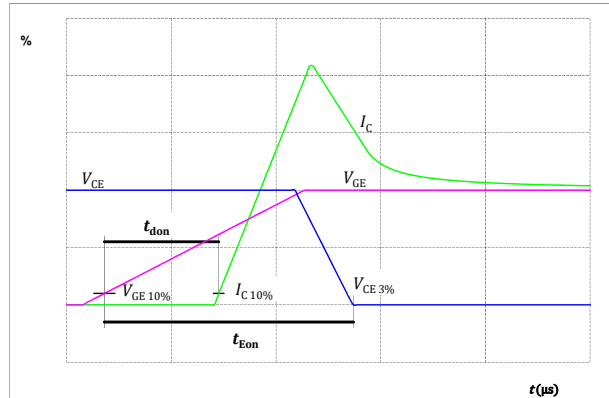


figure 27. MOSFET

Turn-off Switching Waveforms & definition of t_f

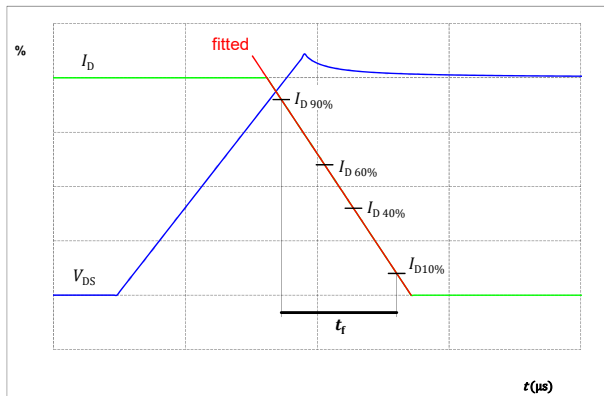
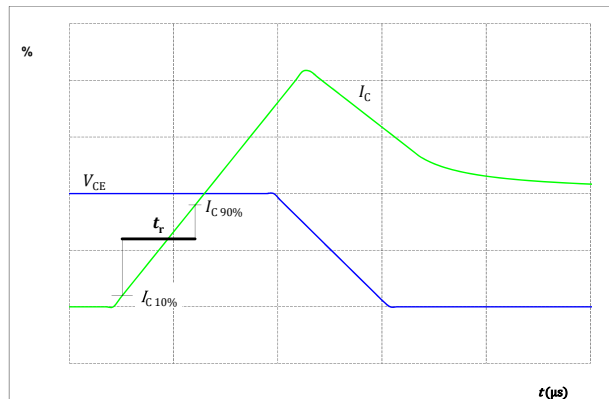


figure 28. MOSFET

Turn-on Switching Waveforms & definition of t_r





Boost Switching Definitions

figure 29. FWD

Turn-off Switching Waveforms & definition of t_{tr}

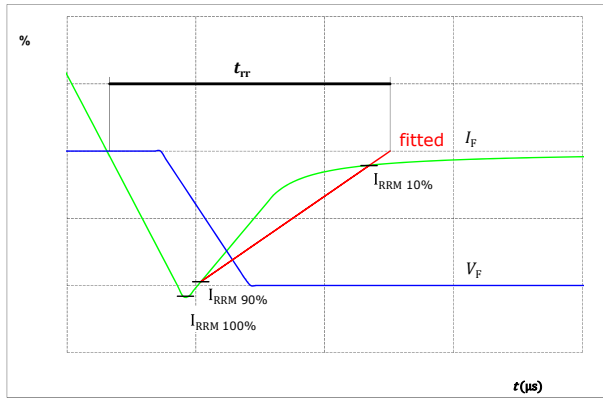


figure 30. FWD

Turn-on Switching Waveforms & definition of t_{Qr} (t_{Qr} = integrating time for Q_r)

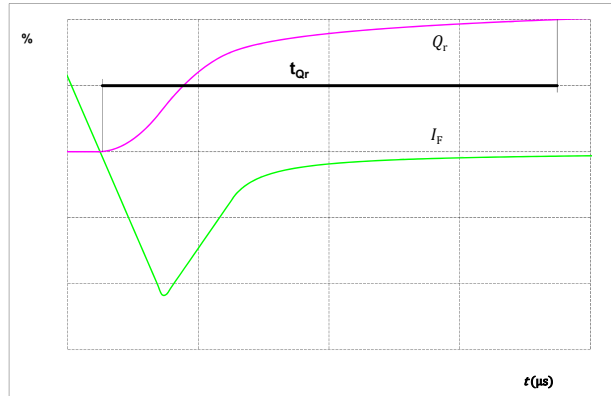
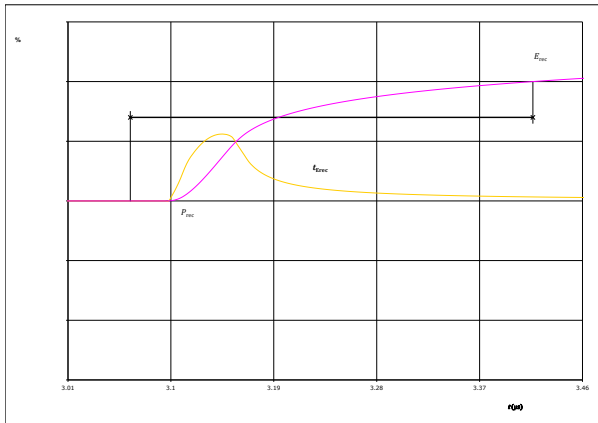


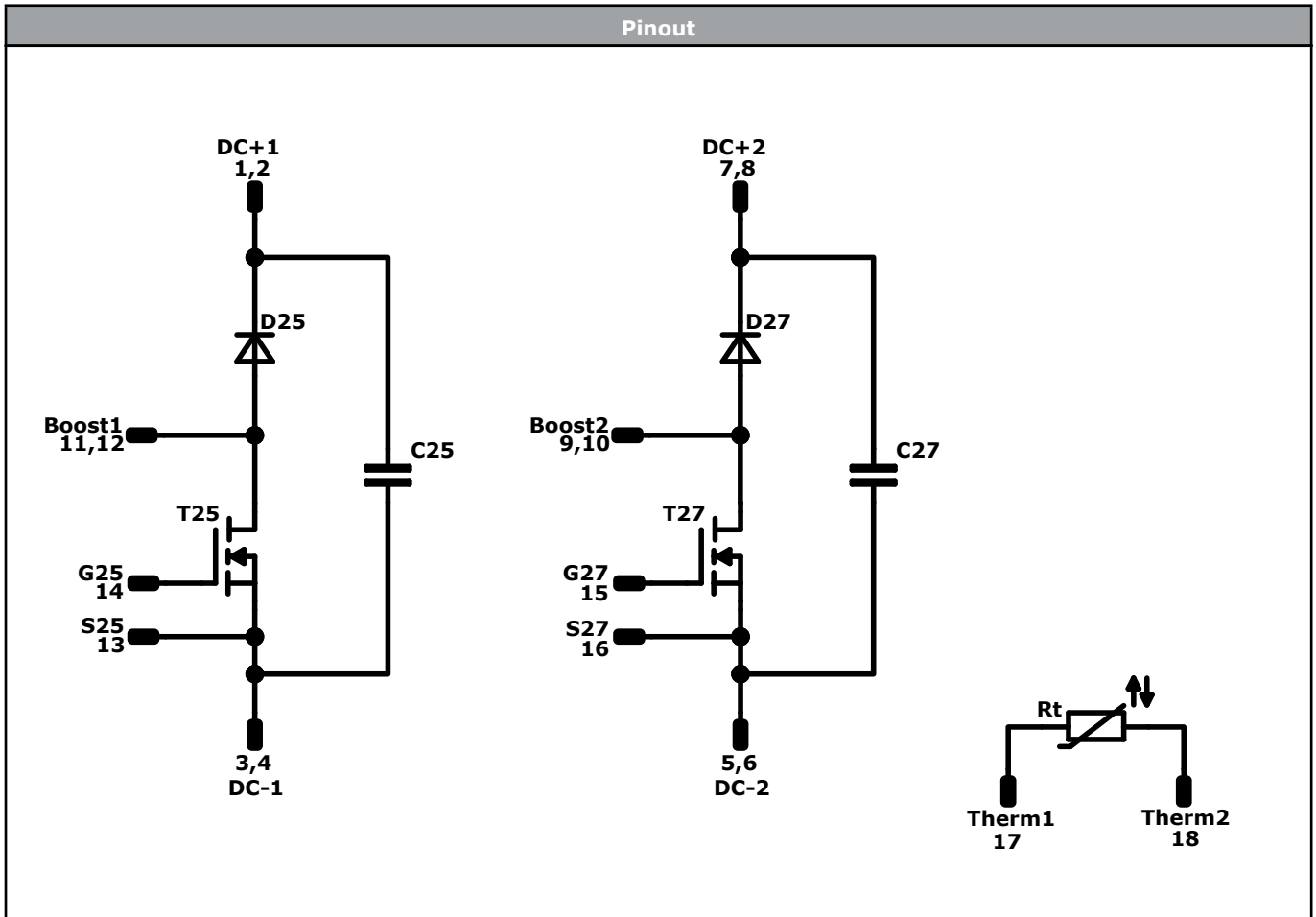
figure 31. FWD

Turn-on Switching Waveforms & definition of t_{Erec} (t_{Erec} = integrating time for E_{rec})





Vincotech



Identification					
ID	Component	Voltage	Current	Function	Comment
T25, T27	MOSFET	650 V	42 mΩ	Boost Switch	
D25, D27	FWD	650 V	20 A	Boost Diode	
C25, C27	Capacitor	630 V		Capacitor (DC)	
Rt	Thermistor			Thermistor	




Vincotech

Packaging instruction				
Standard packaging quantity (SPQ) 135	>SPQ	Standard	<SPQ	Sample

Handling instruction
Handling instructions for <i>flow 0</i> packages see vincotech.com website.

Package data
Package data for <i>flow 0</i> packages see vincotech.com website.

Vincotech thermistor reference
See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website. 

Document No.:	Date:	Modification:	Pages
10-FZ07B2A042UF01-PB53L93-D1-14	9 Jul. 2021		

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.